



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Manufacturing Info/ Material Info	Subsectionals	D, A																									
Supplier Information																																		
Company Name	TE Connectivity	Request Document ID		Contact Name	Wu, Cc	Contact Title	Prod Compliance Engineer, China CIS Compliance																											
Company Unique ID	TE Connectivity	Response Date	2016-02-26	Contact Email	cc.wu@te.com																													
Contact Phone Number		86-21-33259321																																
Legal Statement																																		
Supplier Acceptance	true																																	
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The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.																																		
Product																																		
Manufacturer Item number	1-794070-0	Amount	5730.100708	Version	-	Identity																												
Manufacturer Item Name	20P MINI UMNL HDR W/DH SN LF	Weight Uom	mg	Mfr Site		Authority																												
Date		UOM	Each																															
EUROHS-0508	Product(s) meets EU RoHS requirement without any exemptions																																	
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products																																	
EUREACH-0615	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed																																	
Manufacturing Information																																		
J-STD-020 MSL Rating		Max Total a Wave Time		Ramp Rate		Wave Additional Info																												
Classification Temp		Max Wave Solder Time	10.0	Ramp Down Rate		Psi Rating Reflow																												
Max Time Within 5		Psi Rating Wave		Package Designator		Size	0.0																											
Time Above 217		Reflow Additional Info		Preheat Max Temp		Terminal Base Alloy	NAC																											
Preheat Duration		bulk Solder Termination	NAC	Nbr or Reflow Cycles		Terminal Plating	NAC																											
Preheat Min Temp		Nbr of Instances	0	Component Temp Spike		Shape	NAC																											
Product Disclosure																																		
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption																									
Sub-Item	1	MINI UMNL BAND PIN SNNI*				20.0	110.664	mg																										
Material	2	Brass Wire				20.0	108.0	mg																										
Substance	3	Copper	Supplier	7440-50-8	71.5	20.0	77.22	mg																										
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	20.0	0.00108	mg																										
Substance	3	Zinc	Supplier	7440-66-6	28.0226	20.0	30.26441	mg																										
Substance	3	Manganese	Supplier	7439-96-5	0.05	20.0	0.054	mg																										
Substance	3	Chromium	Supplier	7440-47-3	0.0010	20.0	0.00108	mg																										
Substance	3	Iron	Supplier	7439-89-6	0.05	20.0	0.054	mg																										
Substance	3	Cobalt	Supplier	7440-48-4	0.1	20.0	0.108	mg																										
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	20.0	0.010692	mg																										
Substance	3	Antimony	Supplier	7440-36-0	0.01	20.0	0.0108	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	20.0	0.054	mg																										
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	20.0	0.0054	mg																										
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	20.0	5.4E-4	mg																										
Substance	3	Nickel	Nickel	7440-02-0	0.2	20.0	0.216	mg																										
Material	2	Tin Plate				20.0	2.059	mg																										
Substance	3	Tin	Supplier	7440-31-5	99.73	20.0	2.05344	mg																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	20.0	0.004118	mg																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	20.0	0.0014413	mg																										

Material	2	Nickel Plate				20.0	0.605	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	20.0	0.00121	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	20.0	6.05E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	20.0	0.60318	mg	
Sub-Item	1	20P MINI UMNL VRT HDR HSG W/D				1.0	3516.820708	mg	
Material	2	PA				1.0	3516.820708	mg	
Substance	3	Water	Supplier	7732-18-5	0.3262	1.0	11.47187	mg	
Substance	3	2H-Azepin-2-one, hexahydro-	Supplier	105-60-2	0.4637	1.0	16.3075	mg	
Substance	3	Siloxanes and Silicones, di-Me	Supplier	63148-62-9	3.0E-4	1.0	0.01055046	mg	
Substance	3	Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl]	Supplier	32131-17-2	0.9451	1.0	33.23747	mg	
Substance	3	Benzenepropanamide, N,N-1,6-hexanediylbis[3,5-bis(1,1-dimethylethyl)-4-hydroxy-	Supplier	23128-74-7	0.4004	1.0	14.08135	mg	
Substance	3	1,2-Ethanediamine	Supplier	107-15-3	0.0033	1.0	0.11606	mg	
Substance	3	Phosphoric acid, sodium salt, hydrate (1:2:12)	Supplier	10039-32-4	0.025	1.0	0.87921	mg	
Substance	3	Octadecanoic acid, calcium salt (2:1)	Supplier	1592-23-0	0.2012	1.0	7.07584	mg	
Substance	3	Octadecanamide, N,N-1,2-ethanediylbis-	Supplier	110-30-5	0.1901	1.0	6.68548	mg	
Substance	3	1,3,5-Triazine-2,4,6-(1H,3H,5H)-trione, compd. with 1,3,5-triazine-2,4,6-triamine (1:1)	Supplier	37640-57-6	9.0717	1.0	319.03542	mg	
Substance	3	Hexanedioic acid, polymer with hexahydro-2H-azepin-2-one and 1,6-hexanediamine	Supplier	24993-04-2	88.373	1.0	3107.91996	mg	